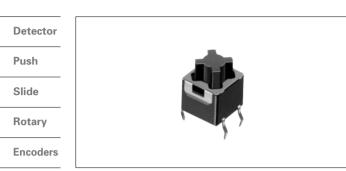
TACT Switch™ Long-travel with High Operation Force (Snap-in Type)

SKPF Series



8×9mm size. Combination of long travel and high operation force prevent malfunction.



Power

Dual-in-line Package Type

TACT Switch™

Custom-Products

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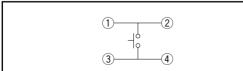
Product No.	Operating force	Operating direction	Travel (mm)	Rating (max.)	Rating (min.)	Operating life (5mA 5V DC)	Initial contact resistance	Minimum order unit (pcs.)
SKPFAAA010	3.92N	Vertical	1.75	5mA 12V DC	10μ Α 1V DC	100,000cycles	1k max.	1,000
SKPFACA010	1.96N	vertical					1k max.	

Dimensions Unit:mm Sharp Feeling PC board mounting hole dimensions Style (Viewed from switch mounting face) Soft Feeling Snap-in Туре Surface Mount Type Radial Туре ŝ 6 4-ø1 holes 6.8 8.7

0.7

4.5

📕 Circuit Diagram



Note

0.7

Using a 1.6mm thick PC board is recommended.



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List of Varieties

Soft Feeling Type

	Series		SKEG	SKPE	SKEG	SKEY	SKPF	SKPM	SKPN	SKPG	SKPL	SKPD
	Photo				\$		R.					
	Туре		,	/	Snap–in	7	, ,	Si	urface moi	unt	Rad	dial
F	eature	e	Snap-in Surface mount Radial Horizontal High operation force Low contact Round terminal and									
				type		and long stroke	resis	tance		low contact resistance		
Operating direction	Vert	tical										
ting	Horiz	ontal		1			,		1	1		
		w	6	6.6	7.5	7.8	8	5.9	6	6.6	<i>∳</i> 6.45	7.8
Dimensior (mm)		D	0	6.3	9.9	7.0	9	6	6.7	6.3		7.0
		н	7	5	7.3	5	10	5	7		5	
Contact					Carbon			Sil	ver	Carbon	Silver	Carbon
Operation force coverage		1N	1	Î Î	1	Ţ	Ţ	Ĵ	\$	↓ ↓	\$	Ţ
	-	5N										
Grou	nd terr	ninal										
Operating temperature range		-20 to +70 SKEG										
		-40 to +90										
Performance Insulation resistance Voltage proof		100M min. 100V DC SKEY/PD : 50M min. 100V DC										
trical		Oltage 250V AC for 1min. SKPN : 200V AC for 1min. SKEY/PD : 100V AC for 1min.										
	Vibra		10 to 55 to 10Hz/min., the amplitude is 1.5mm for all the frequencies, in the 3 direction of X, Y and Z for 2hours respectively									
Durability	Lifetime Shall be in accordance with individual specifications.											
<	Co	old	-30 ± 2 for 96h									
5			80 ± 2 for 96h									
Environ		heat										
Environmental	Dry	heat o heat				60 +	2 90 to 9	95%BH for	r 96h			

D epth. The most outer dimension excluding terminal portion.
H : Height. The minimum dimension if there are variances.



260°C max. 3 sec max.

Time

230°C

40s max.

Soldering Conditions

Condition for Reflow

Available for Surface Mount Type.

1. Heating method: Double heating method with infrared heater.

Temperature (°C)

180

150

2. Temperature measurement: Thermocouple 0.1 to 0.2 CA(K) or CC(T) at solder joints (copper foil surface). A heat resistive tape should be used to fix thermocouple.

Push 3. Temperature profile

Slide

Detector

Rotarv

Encoders

Power

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TACT Switch[™]

Custom-Products

Note

1. The above temperature shall be measured on the mounting surface of a PC board. There are cases where the PC board's temperature greatly differs from that of the switch, depending on the material, size, thickness of PC boards and others. The above-stated conditions shall also apply to switch surface temperatures.

3 to 4min.

Time inside soldering equipment

120 sec max. (pre-heating

2. Soldering conditions differ depending on reflow soldering machines. Prior verification of soldering condition is highly recommended.

Sharp Feeling Soft Feeling Snap-in Type Surface Mount Type Radial Type

Conditions for Auto-dip Available for Snap-in Type and Radial Type (Except SKHJ, SKHL, SKQJ, SKQK, SKEG series)

Items	Condition					
Flux built-up	Mounting surface should not be exposed to fluk					
Preheating temperature	Ambient temperature of the soldered surface of PC board. 100 max.					
Preheating time	60s max.					
Soldering temperature	260 max.					
Duration of immersion	5s max.					
Number of soldering	2times max.					

Manual Soldering (Except SKRT Series)

ltems	Condition					
Soldering temperature	350 max.					
Duration of soldering	3s max.					
Capacity of soldering iron	60W max.					

Notes

- 1. Consult with us for availability of TACT Switch[™] washing.
- 2. Prevent flux penetration from the top side of the TACT Switch[™].
- 3. Switch terminals and a PC board should not be coated with flux prior to soldering.
- 4. The second soldering should be done after the switch is stable with normal temperature.
- 5. Use the flux with a specific gravity of min 0.81.
- (EC-19S-8 by TAMURA Corporation, or equivalents.)

ALPS